

#### MC33172 MC35172

# Low power dual bipolar operational amplifiers

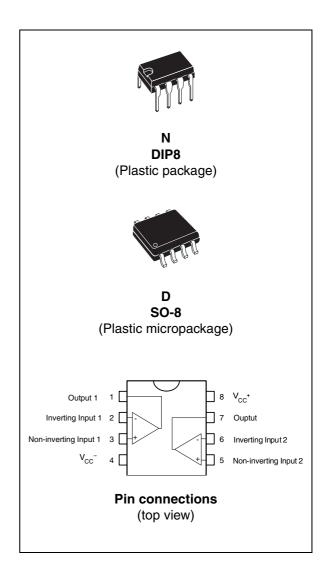
#### **Features**

- Good consumption/speed ratio: only 200 µA for 2.1 MHz, 2 V/µs
- Single (or dual) supply operation from +4 V to +44 V (±2 V to ±22V)
- Wide input common mode mode voltage range including V<sub>CC</sub>-
- Low level output voltage close to V<sub>CC</sub>-: 100 mV typical
- Pin-to-pin compatible with standard dual operational amplifiers

#### **Description**

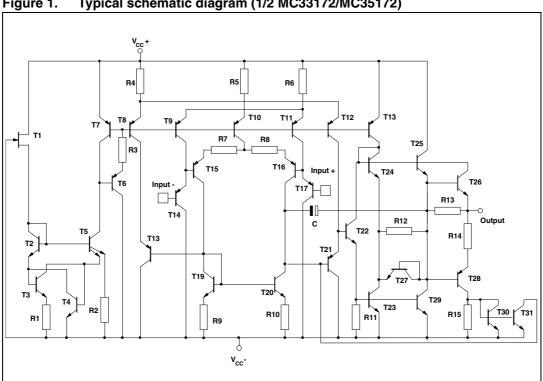
The MC3x172 series are dual bipolar operational amplifiers offering both low consumption (200 μA/Amp) and good speed (2.1 MHz, 2 V/μs).

Moreover, the input common mode range extends down to the lower supply rail, allowing single supply operation from +4 V to +44 V.



MC33172 MC35172 **Circuit schematics** 

#### **Circuit schematics** 1



Typical schematic diagram (1/2 MC33172/MC35172) Figure 1.

#### 2 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings (AMR)

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply voltage	±22	V
V <sub>id</sub>	Differential input voltage	see note <sup>(1)</sup>	V
V <sub>in</sub>	Input voltage	see note 1	V
	Output short-circuit duration	Indefinite	S
T <sub>oper</sub>	Operating free-air temperature range MC33172 MC35172	-40 to 105 -55 to 125	°C
R <sub>thja</sub>	Thermal resistance junction to ambient <sup>(2)</sup> SO-8 DIP8	125 85	°C/W
R <sub>thjc</sub>	Thermal resistance junction to case <sup>(2)</sup> SO-8 DIP8	40 41	°C/W
T <sub>j</sub>	Junction temperature	150	°C
T <sub>stg</sub>	Storage temperature	-65 to 150	°C
	HBM: human body model <sup>(3)</sup>	2	kV
ESD	MM: machine model <sup>(4)</sup>	200	V
	CDM: charged device model <sup>(5)</sup>	1	kV
	Latch-up immunity	Class A	

- 1. Either or both input voltages must not exceed the magnitude of V<sub>CC</sub>.
- 2. Short-circuits can cause excessive heating and destructive dissipation. Values are typical.
- 3. Human body model: A 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5 k $\Omega$  resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
- 4. Machine model: A 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5  $\Omega$ ). This is done for all couples of connected pin combinations while the other pins are floating.
- Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply voltage	±2 to ±22	V

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Electrical characteristics MC33172 MC35172

### 3 Electrical characteristics

Table 3.  $V_{CC}^+ = +15V$ ,  $V_{CC}^- = -15V$ ,  $R_L$  connected to Ground,  $T_{amb} = 25^{\circ}C$  (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
V <sub>io</sub>	Input offset voltage $\begin{aligned} &V_{CC}^{+} = +15V, \ V_{CC}^{-} = -15V, \ V_{ic} = 0V \\ &V_{CC}^{+} = 5V, \ V_{CC}^{-} = 0V, \ V_{ic} = 0V, \ V_{o} = 1.4V \\ &V_{CC}^{+} = +15V, \ V_{CC}^{-} = -15V, \ V_{ic} = 0V, \ T_{min} \leq T_{amb} \leq T_{max} \end{aligned}$		1	4.5 5 6.5	mV
DV <sub>io</sub>	Input offset voltage drift		10		μV/°C
I <sub>io</sub>	Input offset current ( $V_{ic} = 0V$ ) $T_{min} \le T_{amb} \le T_{max}$		5	20 40	nA
I <sub>ib</sub>	Input bias current ( $V_{ic} = 0V$ ) $T_{min} \le T_{amb} \le T_{max}$		20	100 200	nA
A <sub>vd</sub>	Large signal voltage gain ( $R_L = 10k\Omega$ , $V_o = \pm 10V$ ) $T_{min} \le T_{amb} \le T_{max}$	50 25	100		V/mV
V <sub>OH</sub>	High level output voltage $V_{CC}^+=5V,\ V_{CC}^-=0V,\ R_L=10k\Omega$ $V_{CC}^+=+15V,\ V_{CC}=-15V,\ R_L=10k\Omega$ $V_{CC}^+=+15V,\ V_{CC}^-=-15V,\ R_L=10k\Omega,\ T_{min}\leq T_{amb}\leq T_{max}$	3.5 13.6 13.3	4.2 14.2		V
V <sub>OL</sub>	Low level output voltage $\begin{split} &V_{CC}^{+}=5\text{V, }V_{CC}^{-}=0\text{V, }R_{L}=10\text{k}\Omega\\ &V_{CC}^{+}=+15\text{V, }V_{CC}^{-}=-15\text{V, }R_{L}=10\text{k}\Omega\\ &V_{CC}^{+}=+15\text{V, }V_{CC}^{-}=-15\text{V, }R_{L}=10\text{k}\OmegaT_{min}\leq T_{amb}\leq T_{max} \end{split}$		0.1 -14	0.15 -13.6 -13.3	V
I <sub>sc</sub>	Output short-circuit current ( $V_{id} = \pm 1V$ , $V_o = 0V$ ) Source Sink	3 15	6 27		mA
V <sub>icm</sub>	Input common mode voltage range $T_{min} \leq T_{amb} \leq T_{max}$	V <sub>CC</sub> <sup>-</sup> to V <sub>CC</sub> <sup>+</sup> - 1.8) V <sub>CC</sub> <sup>-</sup> to (V <sub>CC</sub> <sup>+</sup> - 2.2)			V
CMR	Common-mode rejection ratio (V <sub>ic</sub> = V <sub>icm-min</sub> )	80	100		dB
SVR	Supply voltage rejection ratio (V <sub>CC</sub> = ±5 to ±15V)	80	100		dB
I <sub>CC</sub>	Supply current $\begin{aligned} &V_{CC}^{+}=5\text{V, }V_{CC}^{-}=0\text{V, no load}\\ &V_{CC}^{+}=+15\text{V, }V_{CC}^{-}=-15\text{V, no load}\\ &V_{CC}^{+}=+15\text{V, }V_{CC}^{-}=-15\text{V no load, }T_{min}\leq T_{amb}\leq T_{max} \end{aligned}$		200 220	250 250 300	μА
SR	Slew rate ( $V_{in} = \pm 10V$ , $R_L = 10k\Omega$ , $C_L = 100pF$ )	1.6	2		V/µs
GBP	Gain bandwidth product $R_L = 10k\Omega$ , $C_L = 100pF$ , $F= 100kHz$	1.4	2.1		MHz
φm	Phase margin ( $R_L = 10k\Omega$ , $C_L = 100pF$ )		45		Degrees
e <sub>n</sub>	Equivalent input noise voltage (F = 1kHz)		29		<u>nV</u> ./Hz
THD	Total harmonic distortion		0.05		%
V <sub>O1</sub> /V <sub>O2</sub>	Channel separation		120		dB

MC33172 MC35172 Package information

### 4 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>.

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Package information MC33172 MC35172

## 4.1 DIP8 package information

Figure 2. DIP8 package mechanical drawing

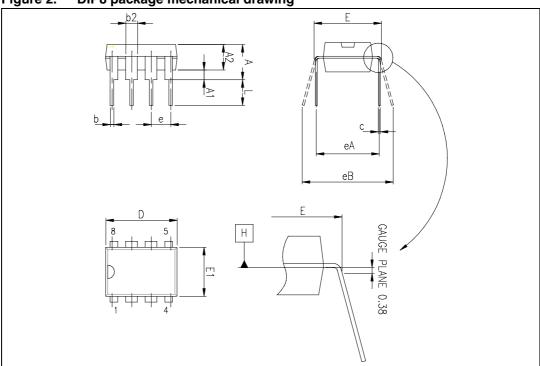


Table 4. DIP8 package mechanical data

	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α			5.33			0.210
A1	0.38			0.015		
A2	2.92	3.30	4.95	0.115	0.130	0.195
b	0.36	0.46	0.56	0.014	0.018	0.022
b2	1.14	1.52	1.78	0.045	0.060	0.070
С	0.20	0.25	0.36	0.008	0.010	0.014
D	9.02	9.27	10.16	0.355	0.365	0.400
E	7.62	7.87	8.26	0.300	0.310	0.325
E1	6.10	6.35	7.11	0.240	0.250	0.280
е		2.54			0.100	
eA		7.62			0.300	
eB			10.92			0.430
L	2.92	3.30	3.81	0.115	0.130	0.150

MC33172 MC35172 Package information

## 4.2 SO-8 package information

Figure 3. SO-8 package mechanical drawing

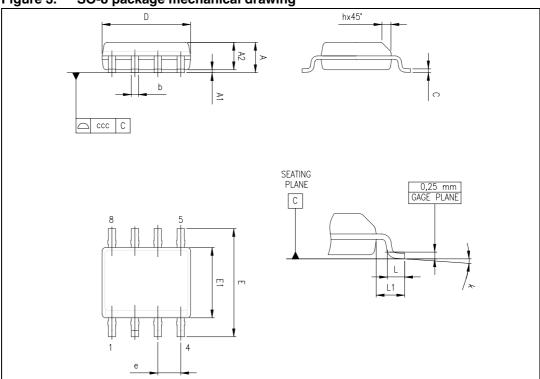


Table 5. SO-8 package mechanical data

	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
С	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
Е	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	1°		8°	1°		8°
ccc			0.10			0.004

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Ordering information MC33172 MC35172

# **5** Ordering information

Table 6. Order codes

Order code	Temperature range	Package	Packing	Marking
MC33172N		DIP8	Tape	MC33172N
MC33172D MC33172DT	-40°C, +105°C	SO-8	Tape or Tape & reel	33172
MC35172N		DIP8	Tape	MC35172N
MC35172D MC35172DT	-55°C, +125°C	SO-8	Tape or Tape & reel	35172

# 6 Revision history

Table 7. Document revision history

Date	Revision	Changes
24-Nov-2001	1	Initial release.
01-Jul-2008	2	ESD values and latch-up immunity added in <i>Table 1: Absolute</i> maximum ratings (AMR).

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